

TD62591AP,TD62592AP,TD62593AP,TD62594AP
TD62595AP,TD62595AF,TD62596AP,TD62596AF
TD62597AP,TD62597AF,TD62598AP,TD62598AF

8CH SINGLE DRIVER

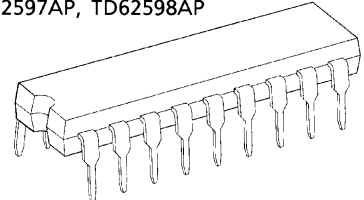
The TD62591AP Series are comprised of eight NPN Transistor Arrays.

Applications include relay, hammer, lamp and display (LED) drivers.

FEATURES

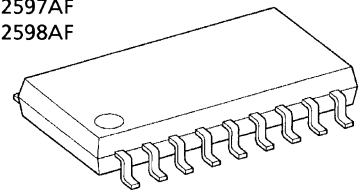
- Output current (single output) 200 mA (Max)
- High sustaining voltage output 50V (Min)
- Low saturation voltage $V_{CE(sat)} = 0.8 \text{ V}$
- @ $I_{out} = 150\text{mA}$ -inputs compatible with various type logic.
TD62591, TD62595AP, TD62595AF : external.
general purpose
- TD62592, TD62596AP, TD62596AF : $10.5 \text{ k}\Omega + 7\text{V}$
zener diode 14~25 V
PMOS
- TD62593, TD62597AP, TD62597AF : $2.7 \text{ k}\Omega$
TTL, 5 V CMOS
- TD62594, TD62598AP, TD62598AF : $10.5 \text{ k}\Omega$
 $6\sim 15 \text{ V PMOS, CMOS}$
- Package type-AP : DIP-18pin
- Package type-AF : SOP-18pin

TD62591AP, TD62592AP, TD62593AP
TD62594AP, TD62595AP, TD62596AP
TD62597AP, TD62598AP



DIP18-P-300-2.54D

TD62595AF
TD62596AF
TD62597AF
TD62598AF



SOP18-P-375-1.27

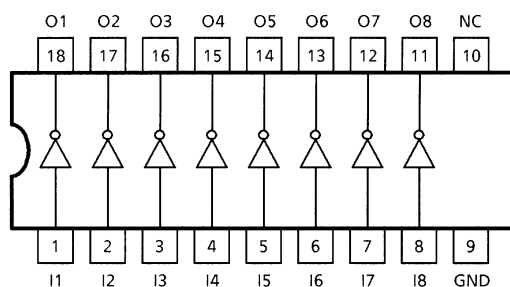
Weight

DIP18-P-300-2.54D : 1.47 g (Typ.)

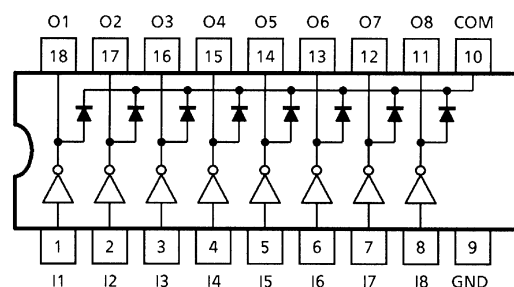
SOP18-P-375-1.27 : 0.5 g (Typ.)

PIN CONNECTION (TOP VIEW)

TD62591AP, TD62592AP, TD62593AP, TD62594AP

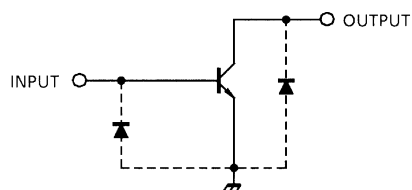


TD62595AP, TD62595AF, TD62596AP, TD62596AF
TD62597AP, TD62597AF, TD62598AP, TD62598AF

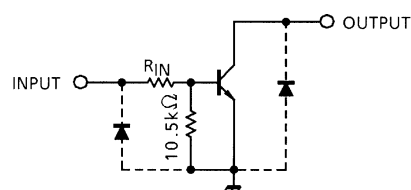


SCHEMATICS (EACH DRIVER)

TD62591AP



TD62592AP, TD62593AP, TD62594AP

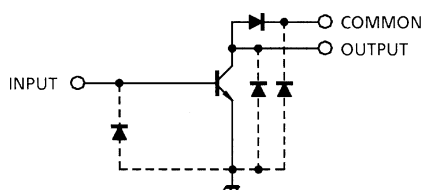


TD62592AP $R_{IN} = 10.5k\Omega + V_Z = 7V$

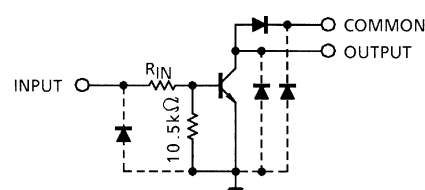
TD62593AP $R_{IN} = 2.7k\Omega$

TD62594AP $R_{IN} = 10.5k\Omega$

TD62595AP, TD62595AF



TD62596AP, TD62596AF, TD62597AP,
TD62597AF, TD62598AP, TD62598AF



TD62596AP $R_{IN} = 10.5k\Omega + V_Z = 7V$

TD62597AP $R_{IN} = 2.7k\Omega$

TD62598AP $R_{IN} = 10.5k\Omega$

Note: The input and output parasitic diodes cannot be used as clamp diodes.

MAXIMUM RATINGS ($T_a = 25^\circ\text{C}$)

CHARACTERISTIC	SYMBOL	RATING	UNIT
Collector-Emitter Voltage	V_{CEO}	50	V
Collector-Base Voltage	V_{CBO}	50	V
Clamp Diode Reverse Voltage	V_R (Note 1)	50	V
Collector Current	I_C	200	mA / ch
Input Voltage	V_{IN} (Note 2)	-0.5~30	V
Input Current	I_{IN} (Note 3)	25	mA
Power Dissipation	P_D (Note 4)	0.96 (Note 5) / 1.47	W
Operating Temperature	T_{opr}	-40~85	$^\circ\text{C}$
Storage Temperature	T_{stg}	-55~150	$^\circ\text{C}$

Note 1: Except TD62591~TD62594AP

Note 2: Except TD62591AP, TD62595AP, TD62595AF

Note 3: Only TD62591AP, TD62595AP, TD62595AF

Note 4: Delated above 25°C in the proportion of $11.7\text{mW} / ^\circ\text{C}$ (AP-Type), $7.7\text{mW} / ^\circ\text{C}$ (F, AF-Type)

Note 5: SOP-18pin

RECOMMENDED OPERATING CONDITIONS (Ta = -40~85°C)

CHARACTERISTIC		SYMBOL	CONDITION	MIN	TYP.	MAX	UNIT
Collector-Emitter Voltage		V_{CEO}	—	0	—	50	V
Collector-Base Voltage		V_{CBO}	—	0	—	50	V
Collector Current		I_C	—	0	—	150	mA / ch
Clamp Diode Reverse Voltage		V_R	(Note1)	7	—	50	V
Input Voltage		V_{IN}	(Note2)	0	—	25	V
Input Current		I_{IN}	(Note3)	0	—	10	mA
Input Voltage (Output On)	TD62592 TD62596	$V_{IN(ON)}$	—	14.0	—	25	V
	TD62593 TD62597			2.4	—	25	
	TD62594 TD62598			7.0	—	25	
Power Dissipation	AP	P_D	—	—	—	0.52	W
	AF		—	—	—	0.355	

ELECTRICAL CHARACTERISTICS (Ta = 25°C unless otherwise noted)

CHARACTERISTIC		SYMBOL	TEST CIR-CUIT	TEST CONDITION	MIN	TYP.	MAX	UNIT
Output Leakage Current		I_{CEX}	1	$V_{CE} = 50\text{ V}, V_{IN} = 0$	—	—	10	μA
Collector-Emitter Saturation Voltage		$V_{CE(sat)}$	2	$I_C = 10\text{ mA}, I_{IN} = 0.4\text{ mA}$	—	—	0.2	V
				$I_C = 150\text{ mA}, I_{IN} = 3.0\text{ mA}$	—	—	0.8	
DC Current Transfer Ratio		h_{FE}	2	$V_{CE} = 10\text{ V}$ $I_C = 10\text{ mA}$	(Note 3) 70	—	—	—
					(Note 2) 50	—	—	
Input Current	TD62591 TD62595	$I_{IN(ON)}$	3	$I_C = 50\text{ mA}$	—	—	0.65	mA
	TD62592 TD62596			$V_{IN} = 14\text{ V}, I_C = 50\text{ mA}$	—	—	0.9	
	TD62593 TD62597			$V_{IN} = 2.4\text{ V}, I_C = 50\text{ mA}$	—	—	0.9	
	TD62594 TD62598			$V_{IN} = 7.0\text{ V}, I_C = 50\text{ mA}$	—	—	0.9	
Turn-On Delay		t_{ON}	4	$V_{OUT} = 50\text{ V}, R_L = 330\ \Omega$	—	0.1	—	μs
Turn-Off Delay		t_{OFF}			—	0.3	—	μs

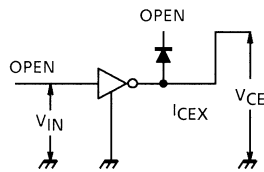
Note 1: Except TD62591~TD62594AP

Note 2: Except TD62591AP, TD62595AP, TD62595AF

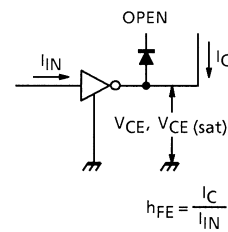
Note 3: Only TD62591AP, TD62595AP, TD62595AF

TEST CIRCUIT

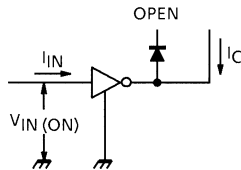
1. I_{CEX}



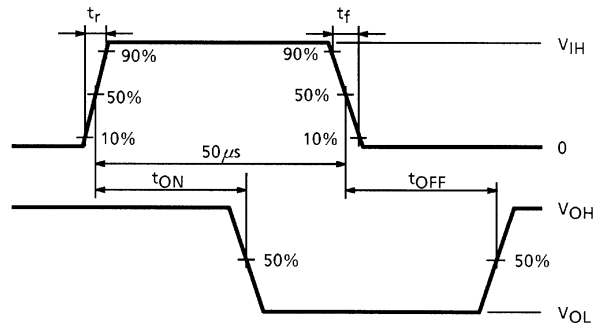
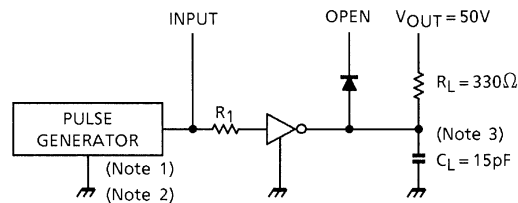
2. h_{FE} , $V_{CE(sat)}$



3. $V_{IN(ON)}$



4. t_{ON} , t_{OFF}



Note 1: Pulse width 50 μ s, duty cycle 10%
Output impedance 50 Ω , $t_r \leq 5$ ns, $t_f \leq 10$ ns

Note 2: See below

Input Condition

TYPE NUMBER	R_{IN}	V_{IH}
TD62591AP, TD62595AP, TD62595AF	2.7 k Ω	3 V
TD62592AP, TD62596AP, TD62596AF	0 Ω	15 V
TD62593AP, TD62597AP, TD62597AF	0 Ω	3 V
TD62594AP, TD62598AP, TD62598AF	0 Ω	10 V

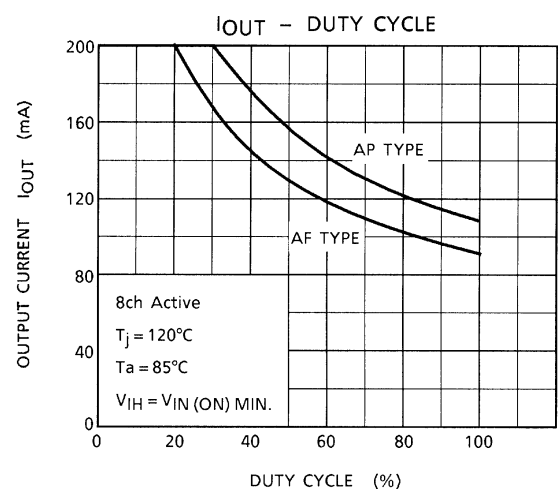
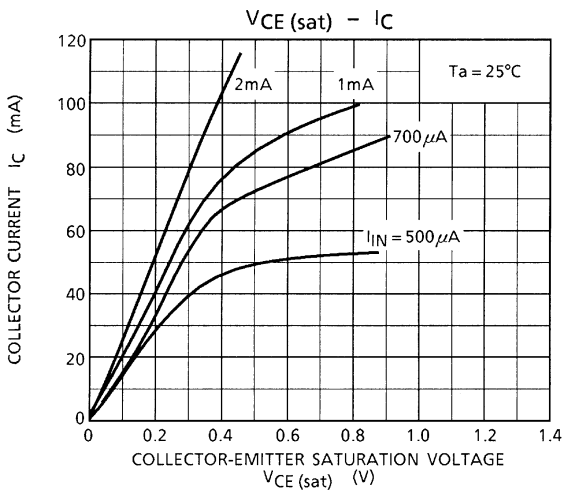
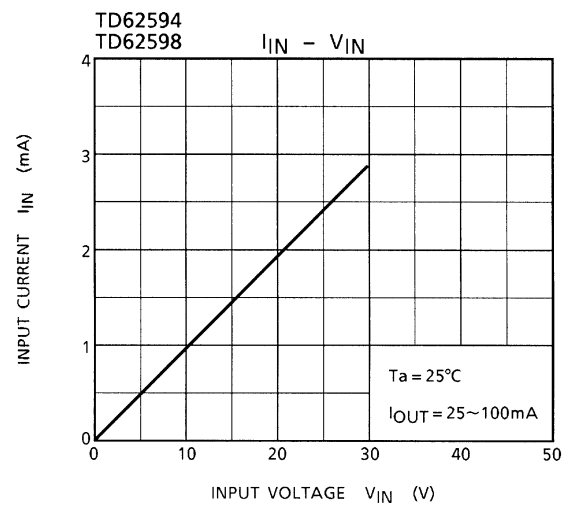
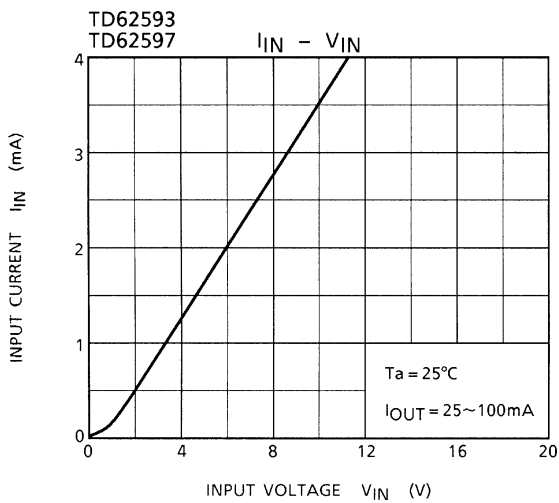
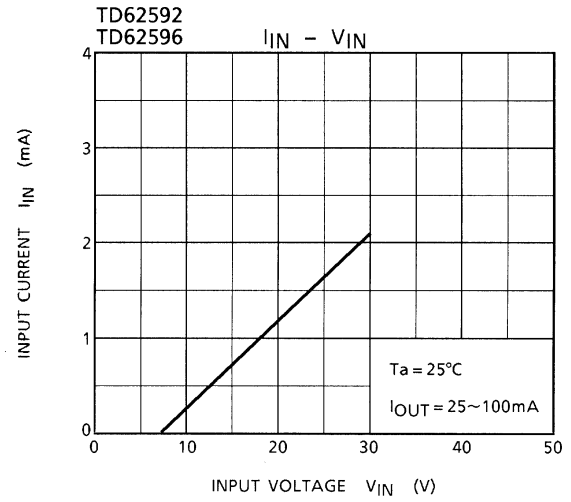
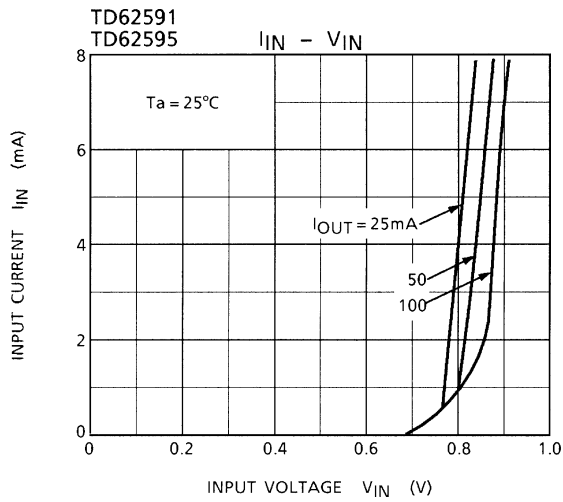
Note 3: C_L includes probe and jig capacitance

PRECAUTIONS for USING

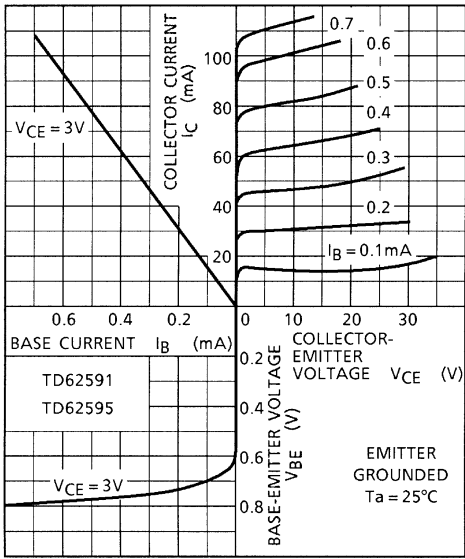
This IC does not integrate protection circuits such as overcurrent and overvoltage protectors.

Thus, if excess current or voltage is applied to the IC, the IC may be damaged. Please design the IC so that excess current or voltage will not be applied to the IC.

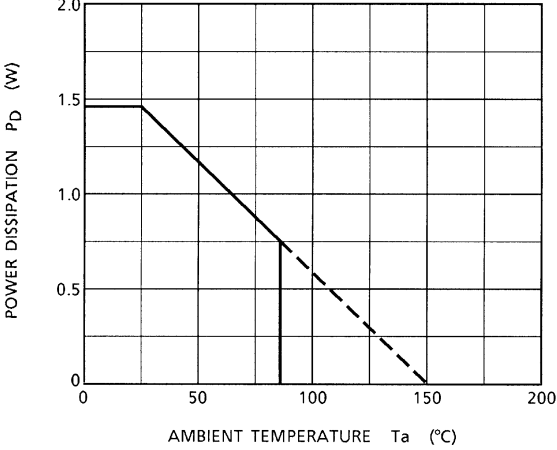
Utmost care is necessary in the design of the output line, VCC and GND line since IC may be destroyed due to short-circuit between outputs, air contamination fault, or fault by improper grounding.



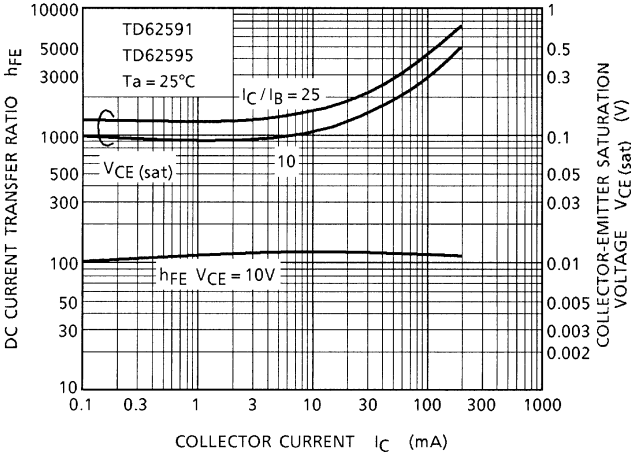
STATIC CHARACTERISTICS



$P_D - T_a$



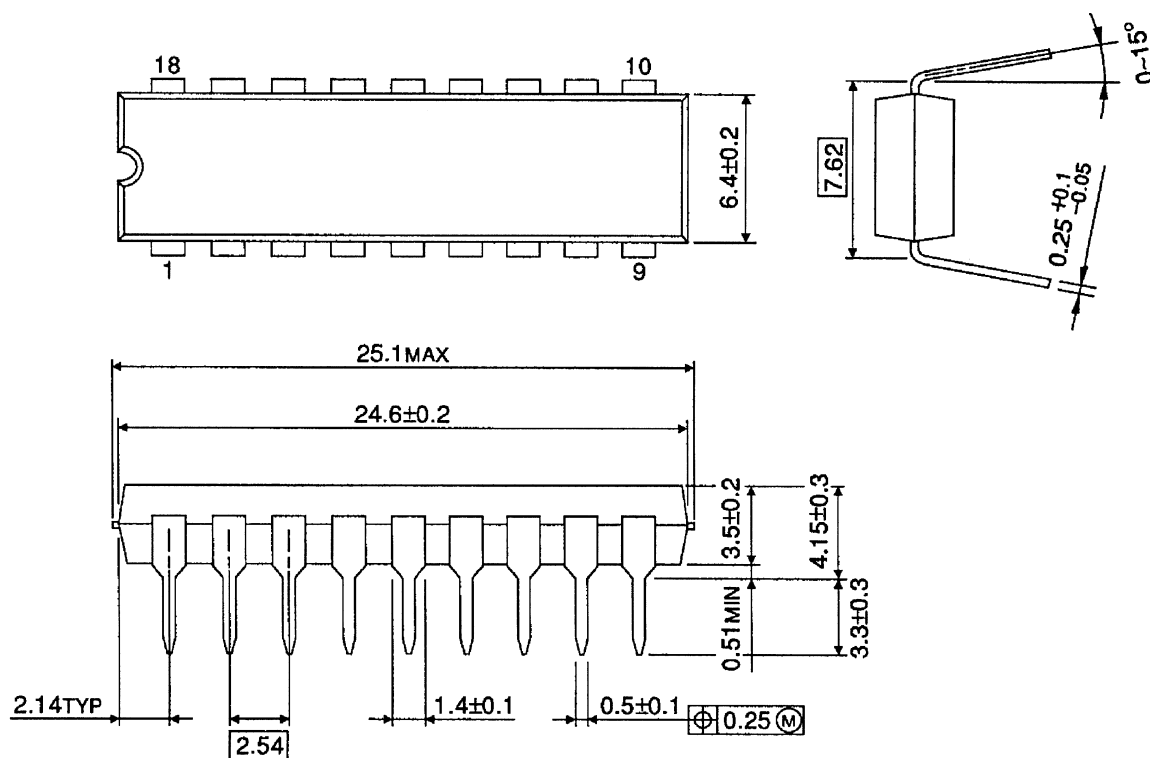
$h_{FE}, V_{CE(sat)} - I_C$



PACKAGE DIMENSIONS

DIP18-P-300-2.54D

Unit: mm

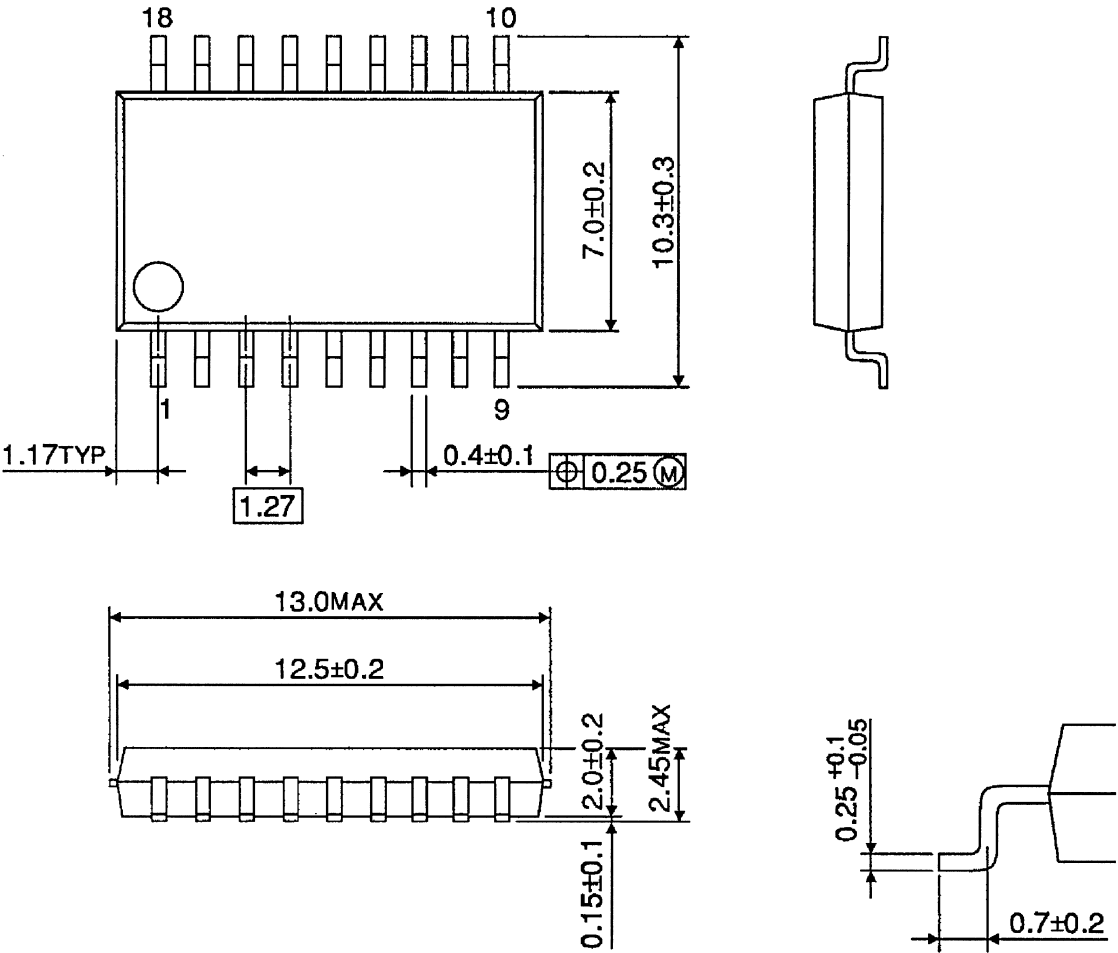


Weight: 1.47 g (Typ.)

PACKAGE DIMENSIONS

SOP18-P-375-1.27

Unit: mm



Weight: 0.50 g (Typ.)

RESTRICTIONS ON PRODUCT USE

000707EBA

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